RLTOKO

TK112xxB

VOLTAGE REGULATOR WITH ON/OFF SWITCH

FEATURES

- High Voltage Precision at $±$ 2.0%
- **Active High On/Off Control**
- Very Low Dropout Voltage 80 mV at 30 mA
- **Very Low Noise**
- Very Small SOT-23L or SOT-89-5 Surface Mount **Packages**
- **Internal Thermal Shutdown**
- **Short Circuit Protection**

DESCRIPTION

The TK112xxB is a low dropout linear regulator with a builtin electronic switch. The internal switch can be controlled by TTL or CMOS logic levels. The device is in the ON state when the control pin is pulled to a logic high level. An external capacitor can be connected to the noise bypass pin to lower the output noise level to 30 µVrms.

An internal PNP pass transistor is used to achieve a low dropout voltage of 80 mV (typ.) at 30 mA load current. The TK112xxB has a very low quiescent current of 170 µA at no load and 1 mA with a 30 mA load. The standby current is typically 100 nA. The internal thermal shutdown circuitry limits the junction temperature to below 150 °C. The load current is internally monitored and the device will shutdown in the presence of a short circuit or overcurrent condition at the output.

APPLICATIONS

- **Battery Powered Systems**
- **Cellular Telephones**
- **Pagers**
- **Personal Communications Equipment**
- **Portable Instrumentation**
- **Portable Consumer Equipment**
- **Radio Control Systems**
- **Toys**
- Low Voltage Systems

The TK112xxB is available in either 6 pin SOT-23L or 5 pin SOT-89-5 surface mount packages.

ABSOLUTE MAXIMUM RATINGS

TK112XXB ELECTRICAL CHARACTERISTICS

Test conditions: $T_A = 25 \degree C$, unless otherwise specified.

Note 1: When mounted as recommended. Derate at 4.8 mW/°C for SOT-23L and 6.4 mW/°C for SOT-89-5 packages when ambient temperatures are over 25 °C.

Note 2: For Line Regulation $V_{\Omega} > 5.6$ V, Typ and Max values are 15 and 40 mV.

Note 3: Refer to Definition of Terms.

Note 4: Ripple Rejection and noise voltage are affected by the value and characteristics of the capacitor used.

Note 5: Output noise voltage can be reduced by connecting a capacitor to a noise pass terminal.

Gen. Note: Parameters with min. or max. values are 100% tested at $T_A = 25 \degree C$.

TK112xxB ELECTRICAL CHARACTERISTICS (Table 1)

TK112xxB

TYPICAL PERFORMANCE CHARACTERISTICS

 $T_A = 25$ °C unless otherwise specified **OUTPUT VOLTAGE RESPONSE SHORT CIRCUIT CURRENT LOAD REGULATION (OFF**→ **ON)** $CL = 2.2 \mu F$ V_{\bigodot} (5 mV/Div) 5 $Cn = 0.01 \mu F$ 4 VOUT TYP V O (V) 3 2 $Cn = 0.1 \mu F$ 1 l_{LOAD} = 30 mA 0 150 T=0 200 400 600 800 0 50 100 0 300 l_{OUT} (mA) I O (mA) TIME (μ S) **OUTPUT CURRENT vs. OUTPUT VOLTAGE vs. INPUT LINE REGULATION DROPOUT VOLTAGE VOLTAGE** V_{OUT} (25mV/Div) 50 mV/Div 0 V_OTYP V_OTYP -100 l_O = 0 mA V_{DROP} (mV) V_{DROP} (mV) -200 ln $= 30$ mA -300 $.50_{mA}$ I -400 I 90_m 10 $V_{IN} = V_{OUT}$ V_{IN} (V) 0 200 100 0 20 V_{IN} (V) (50 mV/Div) I O (mA)

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 $T_A = 25$ °C unless otherwise specified

V_{IN} vs. QUIESCENT CURRENT

QUIESCENT CURRENT

DROPOUT VOLTAGE

CONTROL CURRENT

0 2.5 5

2.5

 V_{IN} (V)

0

V_{CONT} (V_{OUT}, ON POINT)

OUTPUT VOLTAGE VARIATION

 $T_A = 25$ °C unless otherwise specified

-50 0 50 100 VOUT(mV) 0 50 2 V T_A (°C) -20 -10 0 10 $4V$ -30 5 V 3 V

LINE VOLTAGE STEP RESPONSE

LOAD CURRENT STEP RESPONSE

NOISE SPECTRUM

NOISE LEVEL vs. C_N

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 $T_A = 25$ °C unless otherwise specified

TK11217B

I OUT vs VOUT

TK11218B

I OUT vs VOUT 0 300 100 200 S
S 1.7 1.6 V_{IN} = 1.8 V 1.8 I O (mA) 1.9 V 2.0 V 2.1 V V 2.4 V

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DEFINITION AND EXPLANATION OF TECHNICAL TERMS

OUTPUT VOLTAGE (V_O)

The output voltage is specified with $V_{IN} = (V_{O(TYP)} + 1 V)$ and I_{Ω} = 30 mA.

DROPOUT VOLTAGE (V_{DROP})

The dropout voltage is the difference between the input voltage and the output voltage at which point the regulator starts to fall out of regulation. Below this value, the output voltage will fall as the input voltage is reduced. It is dependent upon the load current and the junction temperature.

OUTPUT CURRENT (I_O MAX)

The rated output current is specified under the condition where the output voltage drops 0.3 V below the value specified with $I_{\Omega} = 30$ mA. The input voltage is set to V_{Ω} +1 V, and the current is pulsed to minimize temperature effect.

CONTINUOUS OUTPUT CURRENT (I_O)

Normal operating output current. This is limited by package power dissipation.

PULSE OUTPUT CURRENT (I_{O (PULSE)})

Max pulsewidth 5ms, Duty cycle 12.5%: pulse load only

LINE REGULATION (LINE REG)

Line regulation is the ability of the regulator to maintain a constant output voltage as the input voltage changes. The line regulation is specified as the input voltage is changed from $V_{IN} = V_O + 1V$ to $V_{IN} = V_O + 6v$.

LOAD REGULATION (LOAD REG)

Load regulation is the ability of the regulator to maintain a constant output voltage as the load current changes. It is a pulsed measurement to minimize temperature effects with the input voltage set to $V_{1N} = V_0 + 1$ V. The load regulation is specified under two output current step conditions of 1 mA to 60 mA and 1 mA to 100 mA.

QUIESCENT CURRENT (IQ)

The quiescent current is the current which flows through the ground terminal under no load conditions ($I_{\Omega} = 0$ mA).

RIPPLE REJECTION RATIO

Ripple rejection is the ability of the regulator to attenuate the ripple content of the input voltage at the output. It is specified with 100 mVrms, 400 Hz superimposed on the input voltage, where $V_{IN} = V_O + 1.5 V$. The output decoupling capacitor is set to 10 μ F, the noise bypass capacitor is set to 0.1 µF, and the load current is set to 30 mA. Ripple rejection is the ratio of the ripple content of the output vs. the input and is expressed in dB.

STANDBY CURRENT

Standby current is the current which flows into the regulator when the output is turned off by the control function (V_{CONT} $= 0$ V). It is measured with V_{IN} = 8 V (9 V for the 8 V output device.)

SENSOR CIRCUIT

Over current sensor

The overcurrent sensor protects the device in the event that the output is shorted to ground.

Thermal sensor

The thermal sensor protects the device in the event that the junction temperature exceeds the safe value $(T_{\rm J} = 150 \,^{\circ}\text{C})$. This temperature rise can be caused by external heat, excessive power dissipation caused by large input to output voltage drops, or excessive output current. The regulator will shut off when the temperature exceeds the safe value. As the junction temperatures decrease, the regulator will begin to operate again. Under sustained fault conditions, the regulator output will oscillate as the device turns off then resets. Damage may occur to the device under extreme fault conditions.

Reverse Voltage Protection

Reverse voltage protection prevents damage due to the output voltage being higher than the input voltage. This fault condition can occur when the output capacitor remains charged and the input is reduced to zero, or when an external voltage higher than the input voltage is applied to the output side.

DEFINITION AND EXPLANATION OF TECHNICAL TERMS (CONT.) CONTROL FUNCTION

If the control function is not used, connect the control terminal to $\vee_{|N|}$ When the control function is used, the control current can be reduced by inserting a series resistor (Rc) between the control terminal and $\vee_{|{\sf{N}}\cdot}$ The value of this resitor should be determined from the graph below.

ON/OFF RESPONSE WITH CONTROL AND LOAD TRANSIENT RESPONSE DEFINITION AND EXPLANATION OF TECHNICAL TERMS (CONT.)

The turn on time depends upon the value of the output capacitor and the noise bypass capacitor. The turn on time will increase with the value of either capacitor. The graph below shows the relationship between turn on time and load capacitance. If the value of these capacitors is reduced, the load and line regulation will suffer and the noise voltage will increase. If the value of these capacitors is increased, the turn on time will increase.

 $A = 0$ to 30, B = 5 to 35, C = 30 to 60 mA

REDUCTION OF OUTPUT NOISE

Although the architecture of the Toko regulators is designed to minimize semiconductor noise, further reduction can be achieved by the selection of external components. The obvious solution is to increase the size of the output capacitor. A more effective solution would be to add a capacitor to the noise bypass terminal. The value of this capacitor should be 0.1 µf or higher (higher values provide greater noise reduction). Although stable operation is possible without the noise bypass capacitor, this terminal has a high impedance and care should be taken to avoid a large circuit area on the printed circuit board when the capacitor is not used. Please note that several parameters are affected by the value of the capacitors and bench testing is recommended when deviating from standard values.

DEFINITION AND EXPLANATION OF TECHNICAL TERMS (CONT.)

INPUT-OUTPUT CAPACITORS

Linear regulators require an output capacitor in order to maintain regulator loop stability. This capacitor should be selected to insure stable operation over the desired temperature and load range. The graphs below show the effects of capacitance value and equivalent series resistance (ESR) on the stable operation area.

In general, the capacitor should be at least $1 \mu F$ (Aluminum electrolytic) and be rated for the actual ambient operating temperature range. The table below shows typical characteristics for several types and values of capacitance. Please note that the ESR varies widely depending upon manufacturer, type, size, and material.

ESR Capacitance	Aluminum Capacitor	Tantalum Capacitor	Ceramic Capacitor
1.0 μ F	2.4 Ω	2.3 Ω	0.14 Ω
2.2	2.0 Ω	1.9 Ω	$0.059\ \Omega$
3.3	4.6 Ω	1.0 Ω	0.049Ω
10.0	1.4 Ω	0.5Ω	0.025Ω

Note: ESR is measured at 10 KHz.

DEFINITION AND EXPLANATION OF TECHNICAL TERMS (CONT.)

PACKAGE POWER DISSIPATION (P_D)

This is the power dissipation level at which the thermal sensor is activated. The IC contains an internal thermal sensor which monitors the junction temperature. When the junction temperature exceeds the monitor threshold of 150 \degree C, the IC is shutdown. The junction temperature rises as the difference between the input power ($V_{IN}X I_{IN}$) and the output power (V_{OUT} X I_{OUT}) increases. The rate of temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting has good thermal conductivity, the junction temperature will be low even if the power dissipation is great. When mounted on the recommended mounting pad, the power dissipation of the SOT-23L is increased to 600 mW. For operation at ambient temperatures over 25 \degree C, the power dissipation of the SOT-23L device should be derated at 4.8/ mW/°C. The power dissipation of the SOT-89-5 package is 900 mW when mounted as recommended. Derate the power dissipation at 7.2 mW/°C for operation above 25 °C. To determine the power dissipation for shutdown when mounted, attach the device on the actual PCB and deliberately increase the output current (or raise the input voltage) until the thermal protection circuit is activated. Calculate the power dissipation of the device by subtracting the output power from the input power. These measurements should allow for the ambient temperature of the PCB. The value obtained from PD/(150 °C - T_A) is the derating factor. The PCB mounting pad should provide maximum thermal conductivity in order to maintain low device temperatures. As a general rule, the lower the temperature, the better the reliability of the device. The Thermal resistance when mounted is expressed as follows:

$$
T_J = \theta_{JA} \times P_D + T_A
$$

For Toko ICs, the internal limit for junction temperature is 150 °C. If the ambient temperature, T_A is 25 °C, then:

150 °C = θ_{JA} X P_D + 25 °C $\theta_{JA} = 125 \degree C/P_D$

 P_D is the value when the thermal sensor is activated. A simple way to determine PD is to calculate V_{IN} X I_{IN} when the output side is shorted. Input current gradually falls as temperature rises. You should use the value when thermal equilibrium is reached.

The range of currents usable can also be found from the graph below.

Procedure:

- 1.) Find P_D
- 2.) P_{D1} is taken to be P_D X (≈0.8 ~ 0.9)
- 3.) Plot P_{D1} against 25 ^oC
- 4.) Connect P_{D1} to the point corresponding to the 150 °C with a straight line.
- 5.) In design, take a vertical line from the maximum operating temperature (e.g. 75 °C) to the derating curve.
- 6.) Read off the value of P_D against the point at which the vertical line intersects the derating curve. This is taken as the maximum power dissipation, D_{PD} .

The maximum operating current is:

$$
I_{\text{OUT}} = (D_{\text{PD}}/(V_{\text{IN}(\text{MAX})} \cdot V_{\text{OUT}}).
$$

SOT-23L Board Layout SOT-89-5 Board Layout

SOT-23L Power Dissipation Curve SOT-89-5 Power Dissipation Curve

APPLICATION HINTS

Copper pattern should be as large as possible. Power dissipation is 600 mW for SOT-23L and 900 mV for SOT-89-5. A low ESR capacitor is recommended. For low temperature operation, select a capacitor with a low ESR at the lowest operating temperature to prevent oscillation, degradation of ripple rejection and increase in noise. The minimum recommended capacitance is 2.2 µF.

PACKAGE OUTLINE

The information furnished by TOKO, Inc. is believed to be accurate and reliable. However, TOKO reserves the right to make changes or improvements in the design, specification or manufacture of
its products without further

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